

ESD/ESL SERIES END-STACKABLE SMT TYPE



ESD



ESL

FEATURES

- End stackable for standard 0.1" integrated circuit pitch.
- Molded 0.3" integrated circuit packing outline allowing automatic insertion.
- Smaller size makes better heat convection during PC board reflow wave soldering.
- Top tape sealed to withstand wave soldering, board washing.
- All plastics are UL 94V-0 grade fire retardant.
- Twin contacts designed to ensure stable contact.
- Gold plated contact to ensure low contact resistance and Tin plated terminals to prevent contamination during soldering.
- RoHS Compliant

APPLICATIONS

- Numerical setting for computer terminal equipment
- Price setting for vending machines
- Programming for game machines
- Programming for industrial equipment and measuring instruments

SPECIFICATIONS

1.ELECTRICAL

 Contact rating 	switching	25mA, 24VDC	
	non-switching	100mA	
 Contact resistance 	initial	50mΩ Max.	
	after life test	100mΩ Max.	
 Insulation resistance 		1000MΩ Min. at 100VDC	
Dielectric strength		500VDC Min. for 60 seconds	
 Capacitance between adjacent switches 5pF Max. 			

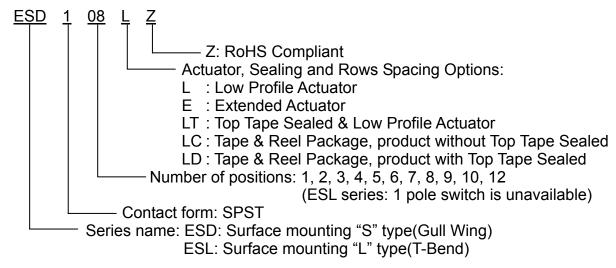
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2.MECHANICAL and ENVIRONMENTAL

• Temperature rating	operating	-40°C to +85℃
	storage	-40°C to +85°C
Operation force		800g Max.
 Mechanical life 		2000 operations
Humidity		95% RH, 40°C for 96 Hrs.
Vibration		10Hz-55Hz-10Hz for 6 Hrs.
 Resistance to soldering heat 		Solder reflow:peak temperature 260°C Max.
 Reflow soldering process for SMT type 		Reference IEC 61760

PART NUMBERING SYSTEM

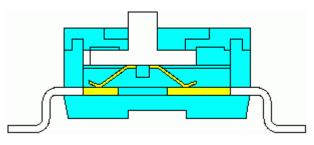


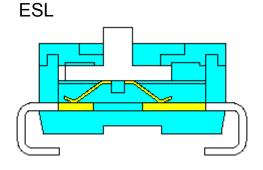
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CONSTRUCTION

ESD





OPTIONS

1.Special marking is available 2.Extended Actuator

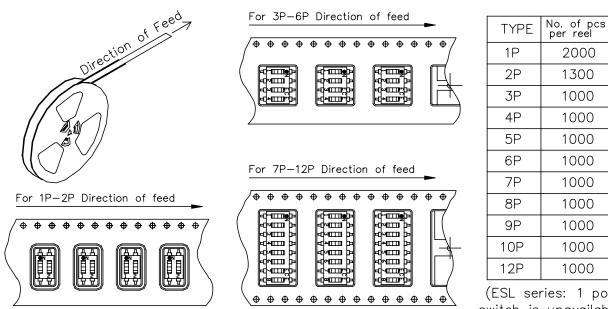


3.Top Tape Sealed



PACKAGING

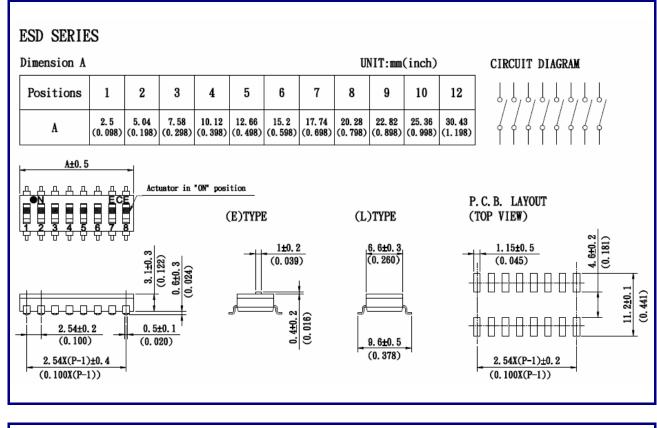
1.Tape & Reel Packaging (per EIA STANDARD)



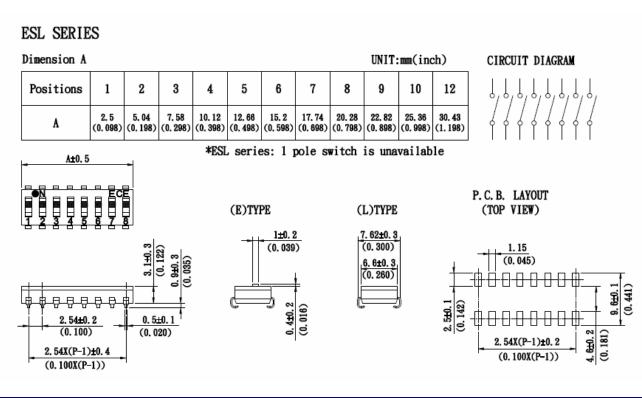
(ESL series: 1 pole switch is unavailable)



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Switch



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